2SB0945 (2SB945)

Silicon PNP epitaxial planar type

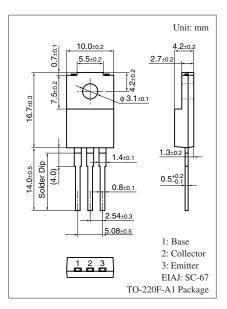
For power switching Complementary to 2SD1270

Features

- \bullet Low collector-emitter saturation voltage $V_{\mbox{CE(sat)}}$
- \bullet Satisfactory linearity of forward current transfer ratio h_{FE}
- \bullet Large collector current I_{C}
- Full-pack package which can be installed to the heat sink with one screw.

Absolute Maximum Ratings $T_C = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Collector-base voltage (En	V _{CBO}	-130	V	
Collector-emitter voltage	V _{CEO}	-80	V	
Emitter-base voltage (Col	V _{EBO}	-7	V	
Collector current	I _C	-5	А	
Peak collector current	I _{CP}	-10	А	
Collector power		P _C	40	W
dissipation	$T_a = 25^{\circ}C$		2	
Junction temperature		Tj	150	°C
Storage temperature	T _{stg}	-55 to +150	°C	



Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

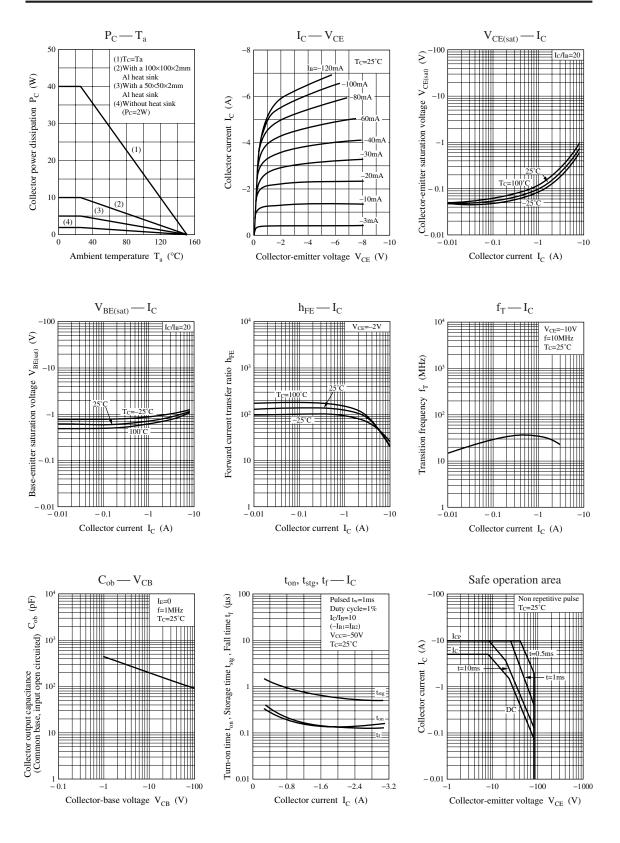
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = -10 \text{ mA}, I_{\rm B} = 0$	-80			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = -100 \text{ V}, I_E = 0$			-10	μΑ
Emitter-base cutoff current (Collector open)	I _{EBO}	$V_{EB} = -5 V, I_C = 0$			-50	μΑ
Forward current transfer ratio	h _{FE1}	$V_{CE} = -2 V, I_C = -0.1 A$	45			
	h _{FE2} *	$V_{CE} = -2 V, I_C = -2 A$	60		260	
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = -4 A, I_B = -0.2 A$			- 0.5	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_{\rm C} = -4$ A, $I_{\rm B} = -0.2$ A			-1.5	V
Transition frequency	f _T	$V_{CE} = -10 \text{ V}, I_C = -0.5 \text{ A}, f = 10 \text{ MHz}$		30		MHz
Turn-on time	t _{on}	$I_C = -2 A, I_{B1} = -0.2 A, I_{B2} = 0.2 A$		0.13		μs
Storage time	t _{stg}	$V_{\rm CC} = -50 \text{ V}$		0.50		μs
Fall time	t _f			0.13		μs

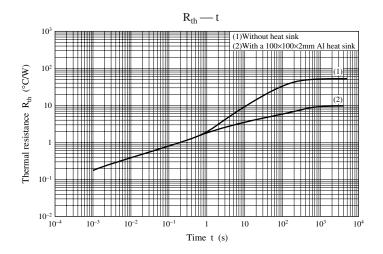
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. *: Rank classification

Rank	R	Q	Р	
h _{FE2}	60 to 120	90 to 180	130 to 260	

Note) The part number in the parenthesis shows conventional part number.

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